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Details

Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	1KB (1K x 8)
Program Memory Type	FLASH
EEPROM Size	16 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f011apj020eg

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Reset, Stop Mode Recovery and Low Voltage Detection

The Reset Controller within the Z8 Encore! XP F082A Series controls Reset and Stop Mode Recovery operation and provides indication of low supply voltage conditions. In typical operation, the following events cause a Reset:

- Power-On Reset (POR)
- Voltage Brown-Out (VBO)
- Watchdog Timer time-out (when configured by the WDT_RES Flash option bit to initiate a reset)
- External $\overline{\text{RESET}}$ pin assertion (when the alternate RESET function is enabled by the GPIO Register)
- On-chip debugger initiated Reset (OCDCTL[0] set to 1)

When the device is in STOP Mode, a Stop Mode Recovery is initiated by either of the following occurrences:

- Watchdog Timer time-out
- GPIO Port input pin transition on an enabled Stop Mode Recovery source

The low voltage detection circuitry on the device (available on the 8-pin product versions only) performs the following functions:

- Generates the VBO reset when the supply voltage drops below a minimum safe level.
- Generates an interrupt when the supply voltage drops below a user-defined level (8-pin devices only).

Reset Types

The Z8 Encore! XP F082A Series provides several different types of Reset operation. Stop Mode Recovery is considered as a form of Reset. Table 8 lists the types of Reset and their operating characteristics. The System Reset is longer if the external crystal oscillator is enabled by the Flash option bits, allowing additional time for oscillator start-up.

tor address. Following Stop Mode Recovery, the STOP bit in the Reset Status (RSTSTAT) Register is set to 1. Table 10 lists the Stop Mode Recovery sources and resulting actions. The text following provides more detailed information about each of the Stop Mode Recovery sources.

Table 10. Stop Mode Recovery Sources and Resulting Action

Operating Mode	Stop Mode Recovery Source	Action
STOP Mode	Watchdog Timer time-out when configured for Reset	Stop Mode Recovery
	Watchdog Timer time-out when configured for interrupt	Stop Mode Recovery followed by interrupt (if interrupts are enabled)
	Data transition on any GPIO port pin enabled as a Stop Mode Recovery source	Stop Mode Recovery
	Assertion of external RESET Pin	System Reset
	Debug Pin driven Low	System Reset

Stop Mode Recovery Using Watchdog Timer Time-Out

If the Watchdog Timer times out during STOP Mode, the device undergoes a Stop Mode Recovery sequence. In the Reset Status (RSTSTAT) Register, the WDT and STOP bits are set to 1. If the Watchdog Timer is configured to generate an interrupt upon time-out and the Z8 Encore! XP F082A Series device is configured to respond to interrupts, the eZ8 CPU services the Watchdog Timer interrupt request following the normal Stop Mode Recovery sequence.

Stop Mode Recovery Using a GPIO Port Pin Transition

Each of the GPIO port pins may be configured as a Stop Mode Recovery input source. On any GPIO pin enabled as a Stop Mode Recovery source, a change in the input pin value (from High to Low or from Low to High) initiates Stop Mode Recovery.

► **Note:** SMR pulses shorter than specified do not trigger a recovery (see [Table 135](#) on page 233). In this instance, the STOP bit in the Reset Status (RSTSTAT) Register is set to 1.

! **Caution:** In STOP Mode, the GPIO Port Input Data registers (PxIN) are disabled. The Port Input Data registers record the Port transition only if the signal stays on the Port pin through the end of the Stop Mode Recovery delay. As a result, short pulses on the Port pin can initiate Stop Mode Recovery without being written to the Port Input Data Register or

Bit	Description (Continued)
[4] U0REN	UART 0 Receive Interrupt Request Enable Low Bit
[3] U0TEN	UART 0 Transmit Interrupt Request Enable Low Bit
[2:1]	Reserved These bits are reserved and must be programmed to 00.
[0] ADCEN	ADC Interrupt Request Enable Low Bit

IRQ1 Enable High and Low Bit Registers

Table 41 describes the priority control for IRQ1. The IRQ1 Enable High and Low Bit registers, shown in Tables 41 and 42, form a priority-encoded enabling for interrupts in the Interrupt Request 1 Register.

Table 41. IRQ1 Enable and Priority Encoding

IRQ1ENH[x]	IRQ1ENL[x]	Priority	Description
0	0	Disabled	Disabled
0	1	Level 1	Low
1	0	Level 2	Medium
1	1	Level 3	High

Note: x indicates register bits 0–7.

Table 42. IRQ1 Enable High Bit Register (IRQ1ENH)

Bit	7	6	5	4	3	2	1	0
Field	PA7VENH	PA6CENH	PA5ENH	PA4ENH	PA3ENH	PA2ENH	PA1ENH	PA0ENH
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC4H							

Bit	Description
[7] PA7VENH	Port A Bit[7] or LVD Interrupt Request Enable High Bit
[6] PA6CENH	Port A Bit[7] or Comparator Interrupt Request Enable High Bit
[5:0] PAxENH	Port A Bit[x] Interrupt Request Enable High Bit

See the [Shared Interrupt Select Register \(IRQSS\) Register](#) on page 68 for selection of either the LVD or the comparator as the interrupt source.

Table 43. IRQ1 Enable Low Bit Register (IRQ1ENL)

Bit	7	6	5	4	3	2	1	0
Field	PA7VENL	PA6CENL	PA5ENL	PA4ENL	PA3ENL	PA2ENL	PA1ENL	PA0ENL
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FC5H							

Bit	Description
[7] PA7VENL	Port A Bit[7] or LVD Interrupt Request Enable Low Bit
[6] PA6CENL	Port A Bit[6] or Comparator Interrupt Request Enable Low Bit
[5:0] PAxENL	Port A Bit[x] Interrupt Request Enable Low Bit

IRQ2 Enable High and Low Bit Registers

Table 44 describes the priority control for IRQ2. The IRQ2 Enable High and Low Bit registers, shown in Tables 44 and 45, form a priority-encoded enabling for interrupts in the Interrupt Request 2 Register.

Interrupt Control Register

The Interrupt Control (IRQCTL) Register, shown in Table 49, contains the master enable bit for all interrupts.

Table 49. Interrupt Control Register (IRQCTL)

Bit	7	6	5	4	3	2	1	0
Field	IRQE	Reserved						
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R	R	R	R	R	R	R
Address	FCFH							

Bit	Description
[7] IRQE	Interrupt Request Enable This bit is set to 1 by executing an EI (Enable Interrupts) or IRET (Interrupt Return) instruction, or by a direct register write of a 1 to this bit. It is reset to 0 by executing a DI instruction, eZ8 CPU acknowledgement of an interrupt request, Reset or by a direct register write of a 0 to this bit. 0 = Interrupts are disabled. 1 = Interrupts are enabled.
[6:0]	Reserved These bits are reserved and must be programmed to 0000000.

it is appropriate to have the Timer Output make a state change at a One-Shot time-out (rather than a single cycle pulse), first set the TPOL bit in the Timer Control Register to the start value before enabling ONE-SHOT Mode. After starting the timer, set TPOL to the opposite bit value.

Observe the following steps for configuring a timer for ONE-SHOT Mode and initiating the count:

1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for ONE-SHOT Mode.
 - Set the prescale value.
 - Set the initial output level (High or Low) if using the Timer Output alternate function.
2. Write to the Timer High and Low Byte registers to set the starting count value.
3. Write to the Timer Reload High and Low Byte registers to set the reload value.
4. If appropriate, enable the timer interrupt and set the timer interrupt priority by writing to the relevant interrupt registers.
5. If using the Timer Output function, configure the associated GPIO port pin for the Timer Output alternate function.
6. Write to the Timer Control Register to enable the timer and initiate counting.

In ONE-SHOT Mode, the system clock always provides the timer input. The timer period is computed via the following equation:

$$\text{ONE-SHOT Mode Time-Out Period (s)} = \frac{\text{Reload Value} - \text{Start Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

CONTINUOUS Mode

In CONTINUOUS Mode, the timer counts up to the 16-bit reload value stored in the Timer Reload High and Low Byte registers. The timer input is the system clock. Upon reaching the reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes. Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state (from Low to High or from High to Low) at timer Reload.

Observe the following steps for configuring a timer for CONTINUOUS Mode and initiating the count:

1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for CONTINUOUS Mode

enabled, the Timer Output pin changes state (from Low to High or from High to Low) at timer Reload.

Observe the following steps for configuring a timer for COUNTER Mode and initiating the count:

1. Write to the Timer Control Register to:
 - Disable the timer.
 - Configure the timer for COUNTER Mode.
 - Select either the rising edge or falling edge of the Timer Input signal for the count. This selection also sets the initial logic level (High or Low) for the Timer Output alternate function. However, the Timer Output function is not required to be enabled.
2. Write to the Timer High and Low Byte registers to set the starting count value. This only affects the first pass in COUNTER Mode. After the first timer Reload in COUNTER Mode, counting always begins at the reset value of 0001H. In COUNTER Mode the Timer High and Low Byte registers must be written with the value 0001H.
3. Write to the Timer Reload High and Low Byte registers to set the reload value.
4. If appropriate, enable the timer interrupt and set the timer interrupt priority by writing to the relevant interrupt registers.
5. Configure the associated GPIO port pin for the Timer Input alternate function.
6. If using the Timer Output function, configure the associated GPIO port pin for the Timer Output alternate function.
7. Write to the Timer Control Register to enable the timer.

In COUNTER Mode, the number of Timer Input transitions since the timer start is computed via the following equation:

$$\text{COUNTER Mode Timer Input Transitions} = \text{Current Count Value} - \text{Start Value}$$

COMPARATOR COUNTER Mode

In COMPARATOR COUNTER Mode, the timer counts input transitions from the analog comparator output. The TPOL bit in the Timer Control Register selects whether the count occurs on the rising edge or the falling edge of the comparator output signal. In COMPARATOR COUNTER Mode, the prescaler is disabled.

Timer 0–1 PWM High and Low Byte Registers

The Timer 0–1 PWM High and Low Byte (TxPWMH and TxPWML) registers, shown in Tables 56 and 57, control Pulse-Width Modulator (PWM) operations. These registers also store the Capture values for the CAPTURE and CAPTURE/COMPARE modes.

Table 56. Timer 0–1 PWM High Byte Register (TxPWMH)

Bit	7	6	5	4	3	2	1	0
Field	PWMH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F04H, F0CH							

Table 57. Timer 0–1 PWM Low Byte Register (TxPWML)

Bit	7	6	5	4	3	2	1	0
Field	PWML							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F05H, F0DH							

Bit	Description
[7:0]	Pulse-Width Modulator High and Low Bytes
PWMH, PWML	These two bytes, {PWMH[7:0], PWML[7:0]}, form a 16-bit value that is compared to the current 16-bit timer count. When a match occurs, the PWM output changes state. The PWM output value is set by the TPOL bit in the Timer Control Register (TxCTL1) Register.

The TxPWMH and TxPWML registers also store the 16-bit captured timer value when operating in CAPTURE or CAPTURE/COMPARE modes.

- Set or clear the CTSE bit to enable or disable control from the remote receiver using the $\overline{\text{CTS}}$ pin
6. Check the TDRE bit in the UART Status 0 Register to determine if the Transmit Data Register is empty (indicated by a 1). If empty, continue to [Step 7](#). If the Transmit Data Register is full (indicated by a 0), continue to monitor the TDRE bit until the Transmit Data Register becomes available to receive new data.
 7. Write the UART Control 1 Register to select the outgoing address bit.
 8. Set the Multiprocessor Bit Transmitter (MPBT) if sending an address byte, clear it if sending a data byte.
 9. Write the data byte to the UART Transmit Data Register. The transmitter automatically transfers the data to the Transmit Shift Register and transmits the data.
 10. Make any changes to the Multiprocessor Bit Transmitter (MPBT) value, if appropriate and MULTIPROCESSOR Mode is enabled.
 11. To transmit additional bytes, return to [Step 5](#).

Transmitting Data using the Interrupt-Driven Method

The UART Transmitter interrupt indicates the availability of the Transmit Data Register to accept new data for transmission. Observe the following steps to configure the UART for interrupt-driven data transmission:

1. Write to the UART Baud Rate High and Low Byte registers to set the appropriate baud rate.
2. Enable the UART pin functions by configuring the associated GPIO port pins for alternate function operation.
3. Execute a DI instruction to disable interrupts.
4. Write to the Interrupt control registers to enable the UART Transmitter interrupt and set the acceptable priority.
5. Write to the UART Control 1 Register to enable MULTIPROCESSOR (9-bit) Mode functions, if MULTIPROCESSOR Mode is appropriate.
6. Set the MULTIPROCESSOR Mode Select (MPEN) to Enable MULTIPROCESSOR Mode.
7. Write to the UART Control 0 Register to:
 - Set the transmit enable bit (TEN) to enable the UART for data transmission
 - Enable parity, if appropriate and if MULTIPROCESSOR Mode is not enabled and select either even or odd parity

UART Interrupts

The UART features separate interrupts for the transmitter and the receiver. In addition, when the UART primary functionality is disabled, the Baud Rate Generator can also function as a basic timer with interrupt capability.

Transmitter Interrupts

The transmitter generates a single interrupt when the Transmit Data Register Empty bit (TDRE) is set to 1. This indicates that the transmitter is ready to accept new data for transmission. The TDRE interrupt occurs after the Transmit Shift Register has shifted the first bit of data out. The Transmit Data Register can now be written with the next character to send. This action provides 7 bit periods of latency to load the Transmit Data Register before the Transmit Shift Register completes shifting the current character. Writing to the UART Transmit Data Register clears the TDRE bit to 0.

Receiver Interrupts

The receiver generates an interrupt when any of the following actions occur:

- A data byte is received and is available in the UART Receive Data Register. This interrupt can be disabled independently of the other receiver interrupt sources. The received data interrupt occurs after the receive character has been received and placed in the Receive Data Register. To avoid an overrun error, software must respond to this received data available condition before the next character is completely received.

► **Note:** In MULTIPROCESSOR Mode ($MPEN = 1$), the receive data interrupts are dependent on the multiprocessor configuration and the most recent address byte.

- A break is received.
- An overrun is detected.
- A data framing error is detected.

UART Overrun Errors

When an overrun error condition occurs the UART prevents overwriting of the valid data currently in the Receive Data Register. The Break Detect and Overrun status bits are not displayed until after the valid data has been read.

After the valid data has been read, the UART Status 0 Register is updated to indicate the overrun condition (and Break Detect, if applicable). The RDA bit is set to 1 to indicate that the Receive Data Register contains a data byte. However, because the overrun error occurred, this byte may not contain valid data and must be ignored. The BRKD bit indicates if the overrun was caused by a break condition on the line. After reading the status

The UART data rate is calculated using the following equation:

$$\text{UART Baud Rate (bits/s)} = \frac{\text{System Clock Frequency (Hz)}}{16 \times \text{UART Baud Rate Divisor Value}}$$

For a given UART data rate, calculate the integer baud rate divisor value using the following equation:

$$\text{UART Baud Rate Divisor Value (BRG)} = \text{Round}\left(\frac{\text{System Clock Frequency (Hz)}}{16 \times \text{UART Data Rate (bits/s)}}\right)$$

The baud rate error relative to the acceptable baud rate is calculated using the following equation:

$$\text{UART Baud Rate Error (\%)} = 100 \times \left(\frac{\text{Actual Data Rate} - \text{Desired Data Rate}}{\text{Desired Data Rate}} \right)$$

For reliable communication, the UART baud rate error must never exceed 5 percent. Table 72 provides information about the data rate errors for popular baud rates and commonly used crystal oscillator frequencies.

Table 72. UART Baud Rates

10.0MHz System Clock				5.5296MHz System Clock			
Acceptable Rate (kHz)	BRG Divisor (Decimal)	Actual Rate (kHz)	Error (%)	Acceptable Rate (kHz)	BRG Divisor (Decimal)	Actual Rate (kHz)	Error (%)
1250.0	N/A	N/A	N/A	1250.0	N/A	N/A	N/A
625.0	1	625.0	0.00	625.0	N/A	N/A	N/A
250.0	3	208.33	-16.67	250.0	1	345.6	38.24
115.2	5	125.0	8.51	115.2	3	115.2	0.00
57.6	11	56.8	-1.36	57.6	6	57.6	0.00
38.4	16	39.1	1.73	38.4	9	38.4	0.00
19.2	33	18.9	0.16	19.2	18	19.2	0.00
9.60	65	9.62	0.16	9.60	36	9.60	0.00
4.80	130	4.81	0.16	4.80	72	4.80	0.00
2.40	260	2.40	-0.03	2.40	144	2.40	0.00
1.20	521	1.20	-0.03	1.20	288	1.20	0.00
0.60	1042	0.60	-0.03	0.60	576	0.60	0.00
0.30	2083	0.30	0.2	0.30	1152	0.30	0.00
3.579545MHz System Clock				1.8432MHz System Clock			

Infrared Encoder/Decoder

Z8 Encore! XP F082A Series products contain a fully-functional, high-performance UART to Infrared Encoder/Decoder (endec). The infrared endec is integrated with an on-chip UART to allow easy communication between the Z8 Encore! XP MCU and IrDA Physical Layer Specification, Version 1.3-compliant infrared transceivers. Infrared communication provides secure, reliable, low-cost, point-to-point communication between PCs, PDAs, cell phones, printers and other infrared enabled devices.

Architecture

Figure 16 displays the architecture of the infrared endec.

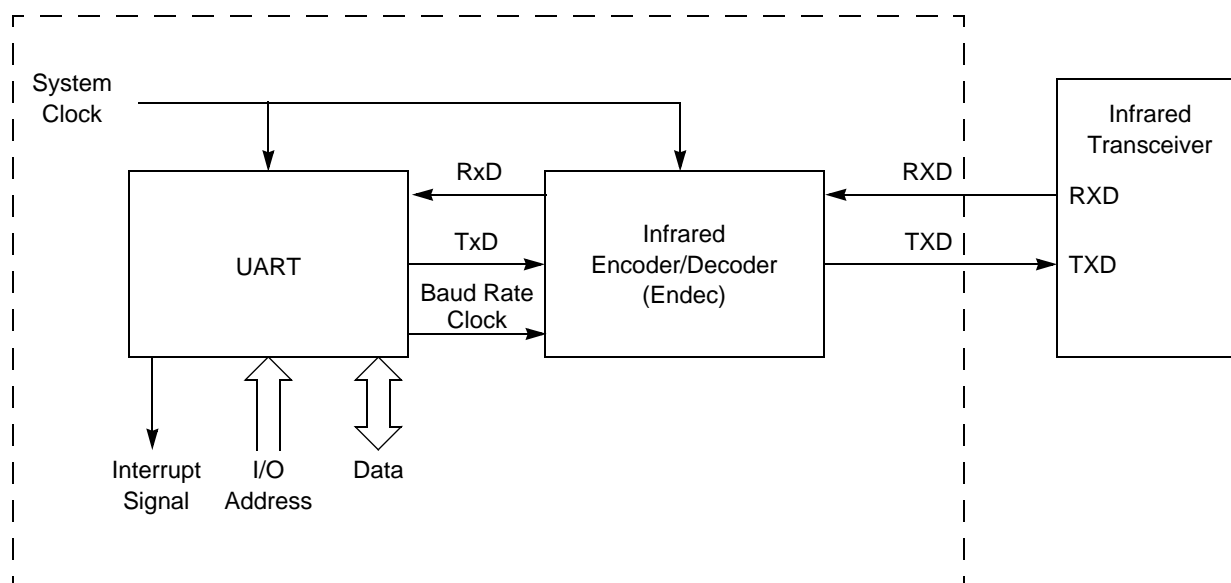


Figure 16. Infrared Data Communication System Block Diagram

Operation

When the infrared endec is enabled, the transmit data from the associated on-chip UART is encoded as digital signals in accordance with the IrDA standard and output to the infrared transceiver through the TXD pin. Likewise, data received from the infrared transceiver is passed to the infrared endec through the RXD pin, decoded by the infrared endec and passed to the UART. Communication is half-duplex, which means simultaneous data transmission and reception is not allowed.

For the reserved values, all input switches are disabled to avoid leakage or other undesirable operation. ADC samples taken with reserved bit settings are undefined.

SINGLE-ENDED Mode:

0000 = ANA0 (transimpedance amp output when enabled)
0001 = ANA1 (transimpedance amp inverting input)
0010 = ANA2 (transimpedance amp noninverting input)
0011 = ANA3
0100 = ANA4
0101 = ANA5
0110 = ANA6
0111 = ANA7
1000 = Reserved
1001 = Reserved
1010 = Reserved
1011 = Reserved
1100 = Hold transimpedance input nodes (ANA1 and ANA2) to ground.
1101 = Reserved
1110 = Temperature Sensor.
1111 = Reserved.

DIFFERENTIAL Mode (noninverting input and inverting input respectively):

0000 = ANA0 and ANA1
0001 = ANA2 and ANA3
0010 = ANA4 and ANA5
0011 = ANA1 and ANA0
0100 = ANA3 and ANA2
0101 = ANA5 and ANA4
0110 = ANA6 and ANA5
0111 = ANA0 and ANA2
1000 = ANA0 and ANA3
1001 = ANA0 and ANA4
1010 = ANA0 and ANA5
1011 = Reserved
1100 = Reserved
1101 = Reserved
1110 = Reserved
1111 = Manual Offset Calibration Mode

ADC Control/Status Register 1

The ADC Control/Status Register 1 (ADCCTL1) configures the input buffer stage, enables the threshold interrupts and contains the status of both threshold triggers. It is also used to select the voltage reference configuration.

Flash Memory

The products in the Z8 Encore! XP F082A Series feature a nonvolatile Flash memory of 8 KB (8192), 4 KB (4096), 2 KB (2048 bytes), or 1 KB (1024) with read/write/erase capability. The Flash Memory can be programmed and erased in-circuit by user code or through the On-Chip Debugger. The features include:

- User controlled read and write protect capability
- Sector-based write protection scheme
- Additional protection schemes against accidental program and erasure

Architecture

The Flash memory array is arranged in pages with 512 bytes per page. The 512-byte page is the minimum Flash block size that can be erased. Each page is divided into 8 rows of 64 bytes.

For program or data protection, the Flash memory is also divided into sectors. In the Z8 Encore! XP F082A Series, these sectors are either 1024 bytes (in the 8KB devices) or 512 bytes (all other memory sizes) in size. Page and sector sizes are not generally equal.

The first 2 bytes of Flash Program memory are used as Flash option bits. For more information about their operation, see the [Flash Option Bits](#) chapter on page 159.

Table 78 describes the Flash memory configuration for each device in the Z8 Encore! XP F082A Series. Figure 21 displays the Flash memory arrangement.

Table 78. Z8 Encore! XP F082A Series Flash Memory Configurations

Part Number	Flash Size KB (Bytes)	Flash Pages	Program Memory Addresses	Flash Sector Size (Bytes)
Z8F08xA	8 (8192)	16	0000H–1FFFFH	1024
Z8F04xA	4 (4096)	8	0000H–0FFFFH	512
Z8F02xA	2 (2048)	4	0000H–07FFFH	512
Z8F01xA	1 (1024)	2	0000H–03FFFH	512

Debugger. Writing an invalid value or an invalid sequence returns the Flash Controller to its locked state. The Write-only Flash Control Register shares its Register File address with the read-only Flash Status Register.

Crystal Oscillator

The products in the Z8 Encore! XP F082A Series contain an on-chip crystal oscillator for use with external crystals with 32kHz to 20MHz frequencies. In addition, the oscillator supports external RC networks with oscillation frequencies up to 4MHz or ceramic resonators with frequencies up to 8MHz. The on-chip crystal oscillator can be used to generate the primary system clock for the internal eZ8 CPU and the majority of the on-chip peripherals. Alternatively, the X_{IN} input pin can also accept a CMOS-level clock input signal (32kHz–20MHz). If an external clock generator is used, the X_{OUT} pin must be left unconnected. The Z8 Encore! XP F082A Series products do not contain an internal clock divider. The frequency of the signal on the X_{IN} input pin determines the frequency of the system clock.

► **Note:** Although the X_{IN} pin can be used as an input for an external clock generator, the CLKIN pin is better suited for such use (see the [System Clock Selection](#) section on page 193).

Operating Modes

The Z8 Encore! XP F082A Series products support four oscillator modes:

- Minimum power for use with very low frequency crystals (32kHz–1 MHz)
- Medium power for use with medium frequency crystals or ceramic resonators (0.5 MHz to 8 MHz)
- Maximum power for use with high frequency crystals (8 MHz to 20 MHz)
- On-chip oscillator configured for use with external RC networks (<4 MHz)

The oscillator mode is selected via user-programmable Flash option bits. See [the Flash Option Bits](#) chapter on page 159 for information.

Crystal Oscillator Operation

The XTLDIS Flash option bit controls whether the crystal oscillator is enabled during reset. The crystal may later be disabled after reset if a new oscillator has been selected as the system clock. If the crystal is manually enabled after reset through the OSCCTL Register, the user code must wait at least 1000 crystal oscillator cycles for the crystal to stabilize. After this, the crystal oscillator may be selected as the system clock.

Table 123. CPU Control Instructions (Continued)

Mnemonic	Operands	Instruction
RCF	—	Reset Carry Flag
SCF	—	Set Carry Flag
SRP	src	Set Register Pointer
STOP	—	STOP Mode
WDT	—	Watchdog Timer Refresh

Table 124. Load Instructions

Mnemonic	Operands	Instruction
CLR	dst	Clear
LD	dst, src	Load
LDC	dst, src	Load Constant to/from Program Memory
LDCI	dst, src	Load Constant to/from Program Memory and Auto-Increment Addresses
LDE	dst, src	Load External Data to/from Data Memory
LDEI	dst, src	Load External Data to/from Data Memory and Auto-Increment Addresses
LDWX	dst, src	Load Word using Extended Addressing
LDX	dst, src	Load using Extended Addressing
LEA	dst, X(src)	Load Effective Address
POP	dst	Pop
POPX	dst	Pop using Extended Addressing
PUSH	src	Push
PUSHX	src	Push using Extended Addressing

Table 125. Logical Instructions

Mnemonic	Operands	Instruction
AND	dst, src	Logical AND
ANDX	dst, src	Logical AND using Extended Addressing
COM	dst	Complement
OR	dst, src	Logical OR
ORX	dst, src	Logical OR using Extended Addressing
XOR	dst, src	Logical Exclusive OR
XORX	dst, src	Logical Exclusive OR using Extended Addressing

AC Characteristics

The section provides information about the AC characteristics and timing. All AC timing information assumes a standard load of 50pF on all outputs.

Table 133. AC Characteristics

		$V_{DD} = 2.7V \text{ to } 3.6V$ $T_A = -40^{\circ}C \text{ to } +105^{\circ}C$ (unless otherwise stated)			
Symbol	Parameter	Minimum	Maximum	Units	Conditions
F _{SYSCLK}	System Clock Frequency	–	20.0	MHz	Read-only from Flash memory
		0.032768	20.0	MHz	Program or erasure of the Flash memory
F _{XTAL}	Crystal Oscillator Frequency	–	20.0	MHz	System clock frequencies below the crystal oscillator minimum require an external clock driver
T _{XIN}	System Clock Period	50	–	ns	T _{CLK} = 1/F _{sysclk}
T _{XINH}	System Clock High Time	20	30	ns	T _{CLK} = 50 ns
T _{XINL}	System Clock Low Time	20	30	ns	T _{CLK} = 50 ns
T _{XINR}	System Clock Rise Time	–	3	ns	T _{CLK} = 50 ns
T _{XINF}	System Clock Fall Time	–	3	ns	T _{CLK} = 50 ns

Table 134. Internal Precision Oscillator Electrical Characteristics

		$V_{DD} = 2.7V \text{ to } 3.6V$ $T_A = -40^{\circ}C \text{ to } +105^{\circ}C$ (unless otherwise stated)			
Symbol	Parameter	Minimum	Typical	Maximum	Units Conditions
F _{IPO}	Internal Precision Oscillator Frequency (High Speed)		5.53		MHz $V_{DD} = 3.3V$ $T_A = 30^{\circ}C$
F _{IPO}	Internal Precision Oscillator Frequency (Low Speed)		32.7		kHz $V_{DD} = 3.3V$ $T_A = 30^{\circ}C$
F _{IPO}	Internal Precision Oscillator Error		±1	±4	%
T _{IPOST}	Internal Precision Oscillator Startup Time		3		μs

General Purpose I/O Port Input Data Sample Timing

Figure 34 displays timing of the GPIO Port input sampling. The input value on a GPIO port pin is sampled on the rising edge of the system clock. The Port value is available to the eZ8 CPU on the second rising clock edge following the change of the Port value.

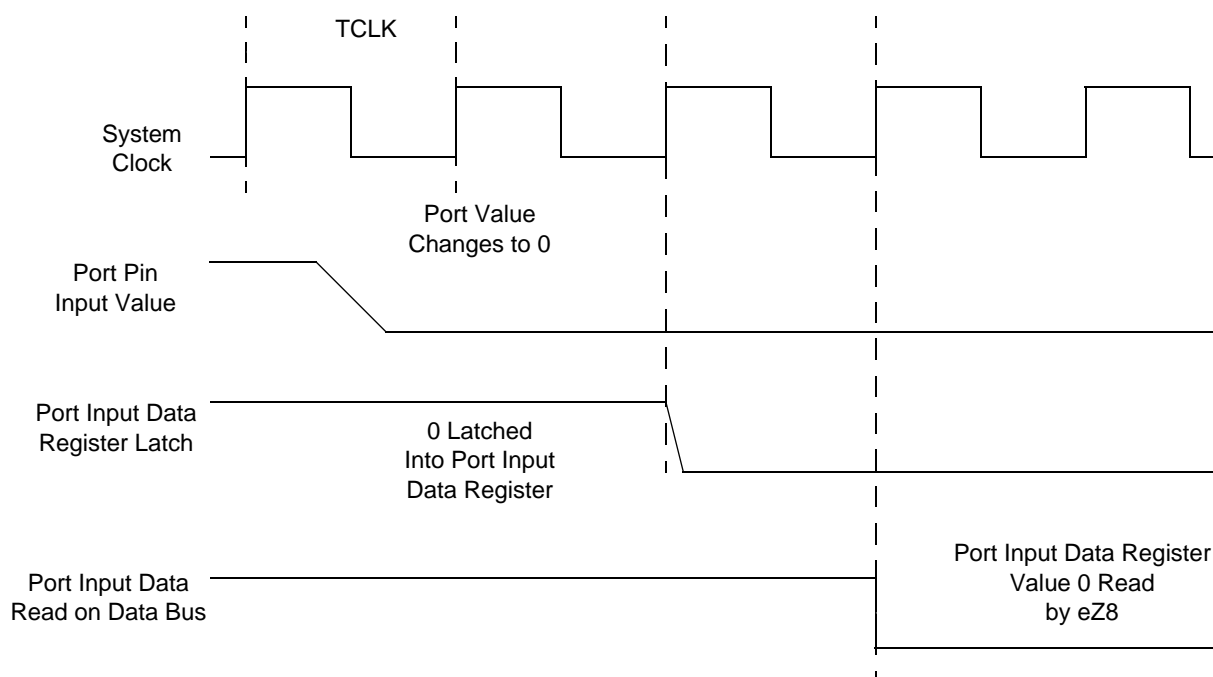


Figure 34. Port Input Sample Timing

Table 143. GPIO Port Input Timing

Parameter	Abbreviation	Delay (ns)	
		Minimum	Maximum
T_{S_PORT}	Port Input Transition to X_{IN} Rise Setup Time (not pictured)	5	–
T_{H_PORT}	X_{IN} Rise to Port Input Transition Hold Time (not pictured)	0	–
T_{SMR}	GPIO Port Pin Pulse Width to ensure Stop Mode Recovery (for GPIO port pins enabled as SMR sources)	1 μ s	